| E |              |   |  |  |  |  |  |  |
|--|--------------|---|--|--|--|--|--|--|
| BRAND  |              | REGO                                      |  |  |  |  |  |  |
| PART NUM   | <b>/</b> BER | FP2H50004-xx35BA-100T-A+PCM               |  |  |  |  |  |  |
| DESCRIPTION  |              | HEAT SINK ASSEMBLY<br>50 x 50 x (15~40)mm |  |  |  |  |  |  |
| CUSTOME  | R            |   |  |  |  |  |  |  |
| CUSTOME  | R P/N        |   |  |  |  |  |  |  |
|  |              |   |  |  |  |  |  |  |
|  |              |   |  |  |  |  |  |  |

DATE

| - | 1 2                  | 3   4   |           | 5                               | 6   |            | 7   | 8                           |     | 9 | 10 |   |
|---|----------------------|---|-----------|---------------------------------|-----|------------|-----|-----------------------------|-----|---|----|---|
| А | (4)<br>41.00         | <u> </u>  |           | (6)<br><u>35.0±0.5</u>          | -   |            |     |                             |     |   |    | А |
|   |                      |   |           |                                 | 0   | +0.5       |     |                             |     |   |    |   |
| В |                      |   |           |                                 |     | (7)<br>(7) |     |                             |     |   | 9  | В |
|   | ( <sup>2)</sup> 50.0 |   |           |                                 | )   |            |     |                             |     |   |    |   |
| С |                      |   |           |                                 |     |            |     |                             |     |   |    | С |
| _ |                      |   |           |                                 |     |            |     |                             |     |   |    |   |
| D |                      | NOTES:<br>PART NAME / NUMBER<br>FP2H50004-1535BA-100T-A+PCM | HEIGHT(H) | FORGED FIN<br>FP2H50004-1535BA- | PCS | PUSH PINS  | PCS | PHASE CHANGE<br>THERMAL PAD | PCS |   |    | D |
|   |                      | FP2H50004-2035BA-100T-A+PCM                                 | 20        | FP2H50004-2035BA-               | 1   |            |     |                             |     |   |    |   |

| _ |
|---|
| E |

E

|   |               | ON REFERENC                  | E                            |                              |                              |         | REGO°                                 | PROPRIETARY NOTE<br>THIS DOCUMENT CONTAIN<br>SHALL NOT BE REPRODUCE | S CONFIDENTIAL INFORMA | ATION AND PROPRIETAR | Y TO REGO EL<br>DEOR ANY PUI | ECTRONICS<br>RPOSE OTHI | AND<br>R THAN |   |
|---|---------------|------------------------------|------------------------------|------------------------------|------------------------------|---------|---------------------------------------|---|------------------------|----------------------|------------------------------|-------------------------|---------------|---|
|   | CONDITIONED   | H+T = 2.9mm<br>IC HEIGHT (H) | H+T = 3.4mm<br>IC HEIGHT (H) | H+T = 3.9mm<br>IC HEIGHT (H) | H+T = 4.4mm<br>IC HEIGHT (H) | PROJECT |                                       | THAT FOR WHICH WAS OBT  |                        | RESSED WRITTEN CONSE | NT OF REGO                   | .LECTRONIC              | s.<br>3°      |   |
| F | APPLIED FORCE | PCB THICKNESS (1)            | 4 10 lb -                    | PCB THICKNESS (1)            | F 10 lb -                    | TITLE   | HEAT SINK ASSEMBLY                    | CHRI  | 5<br>FINISH            | N/A 2<br>SCALE       | 023/05/12                    | ± X.<br>± XX.           | 0.30<br>0.20  | F |
|   | (3~5 lbs)     | 3.7 IDS                      | 4.19 IDS                     | 4.69 IDS                     | 5.19 lbs                     | PART NO | $50 \times 50 \times (15 \sim 40)$ mm | DRAWN   |                        | IITS REV             | <u>1:1</u>                   | SHEET                   | 0.10          |   |
| L | 1             | 2                            |                              | 3                            | 4                            | 5       | 6                                     | 7   | 8                      | 9                    |                              | 10                      | 1011          | I |

FP2H50004-2535BA-1

FP2H50004-3035BA-1

FP2H50004-3535BA-1

FP2H50004-4035BA-1

1 1-1700030925 2

PCM4988 35x35x0.2

1

FP2H50004-2535BA-100T-A+PCM

FP2H50004-3035BA-100T-A+PCM

FP2H50004-3535BA-100T-A+PCM

FP2H50004-4035BA-100T-A+PCM

25

30

35

40





# Honeywell | Thermal Interface Materials

### **PCM4988 High Thermal Conductivity** Phase Change Material

Honeywell's PCM4988, a highly thermally conductive Phase Change Material (PCM) in pad format, was designed to minimize thermal resistance at interfaces. Based on a novel polymer PCM system, this material exhibits excellent wetting at interfaces during typical operating temperature range, resulting in very low surface contact resistance.

A proprietary filler material provides high thermal conductivity (2.0-5.0 W/m°C ) and a low thermal impedance (<0.20°C cm<sup>2</sup>/W), suitable for high performance IC devices.

#### PCM4988 in Convenient Pad Format



\*Stencil printable material is available as PCM4988-SP

### Honeywell TIMs Serve Multiple **Applications**



Automotive & Power



**IT/Enterprise** 



#### Telecommunications



**Consumer Electronics** 



### FEATURES & BENEFITS

- High performance filler and Highly conductive filler Superior handling polymer technology
- Phase change at 45°C
- loading to optimize performance

and reworkability

- Superior reliable thermal performance
- Excellent thermal capability to fit different needs

## PCM4988 Technical Information

| Physical Properties                            | Unit              | Test Method            | PCM4988              |
|--|-------------------|------------------------|----------------------|
| Thermal Conductivity                           | W/m·K             | ASTM D5470             | 2.0                  |
| Thermal Impedance @ no<br>shim (Typical Value) | °C -cm²/W         | ASTM D5470<br>Modified | 0.14                 |
| Specific Gravity                               |                   | ASTM D374              | 2.2                  |
| Viscosity (Typical Value)                      | Pa∙s @2 1/s, 25°C | RehometerHON           | NA                   |
| Volume Resistivity                             | Ω·cm              | ASTM D257-700          | 8.2x10 <sup>14</sup> |
| Thickness Range                                | mm                |                        | 0.20-1.00            |

#### **STORAGE CONDITION**

Refer to product label.

#### THERMAL IMPEDANCE POST RELIABILITY

(No shim @ 40psi) End of Line 0.14 ° C-cm<sup>2</sup>/W Temperature Cycle "B" 0.10 ° C-cm<sup>2</sup>/W (-55°C to +125°C , 1000 cycles)

#### **Product Use**

Clamping pressure and temperature are suggested to achieve a minimum bond line thickness of the thermal interface material, typically less than 1.5 mil (0.038mm) for best thermal performance.

#### More Honeywell TIMs

PCM4988 is part of Honeywell's TIM Solutions family of phase change materials. Whatever the thermal challenge, we offer a TIM product that provides just the right characteristics for your application. Find out more about:

PTM7000 Series PTM5000 Series Hybrid Series

PTM6000 Series PCM45F Series LTM Series By

visiting: electronicmaterials.com



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Authorized Distributor

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